

RV1S9062A

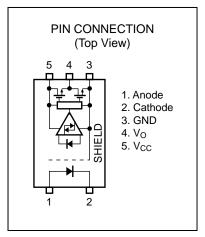
15 Mbps, HIGH CMTI, IPM DRIVER, 5-PIN with 8 mm creepage distance package LSO5 PHOTOCOUPLER

DESCRIPTION

The RV1S9062A is a photocoupler featuring high-speed switching up to 15 Mbps with active low output logic which consists of an AlGaAs LED on the input side and an integrated circuit with a photodiode on the output. The RV1S9062A is designed specifically for high common mode transient immunity (CMTI), wide operating power supply voltage range and high temperature operation up to $T_A = 125$ °C. It is suitable for IPM (Intelligent Power Module) drive.

FEATURES

- Long creepage distance (8 mm MIN.)
- High speed switching (15 Mbps)
- High common mode transient immunity (CM_H, CM_L = $\pm 100 \text{ kV/}\mu \text{s MIN.}$)
- Pulse width distortion ($|t_{PHL} t_{PLH}| = 20 \text{ ns MAX.}$)
- Wide operating power supply voltage range ($V_{CC} = 4.5 \sim 30 \text{ V}$)
- Operating ambient temperature (125 °C MAX.)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Embossed tape product : RV1S9062ACCSP-10Yx#KC0 : 3 000 pcs/reel
- Pb-Free product
- Safety standard
 - UL : UL1577, Double protection
 - CSA : CAN/CSA-C22.2 No.62368-1, Reinforced insulation
 - VDE : DIN EN 60747-5-5 (Option)



APPLICATIONS

- IPM driver
- General purpose inverter

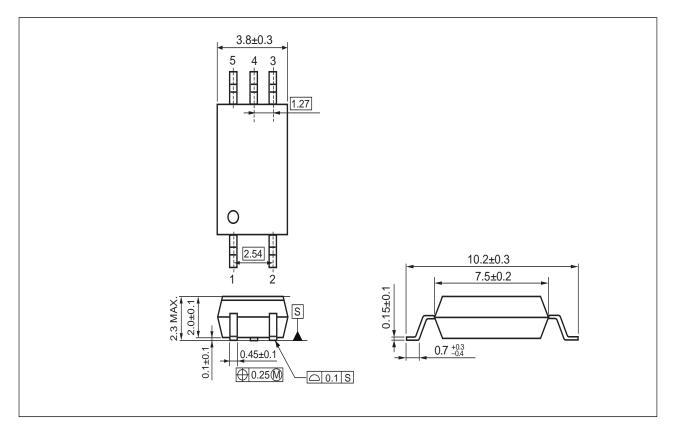
R08DS0270EJ0100 Rev.1.00 May 09, 2022



Apr. 2022

Start of mass production

PACKAGE DIMENSIONS (UNIT: mm)



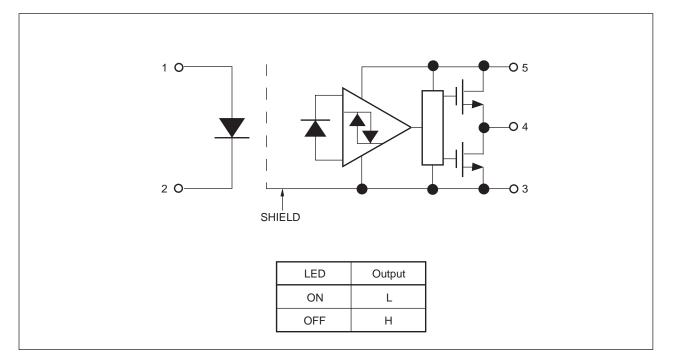
Weight : 0.119 g (Typ.)

PHOTOCOUPLER CONSTRUCTION

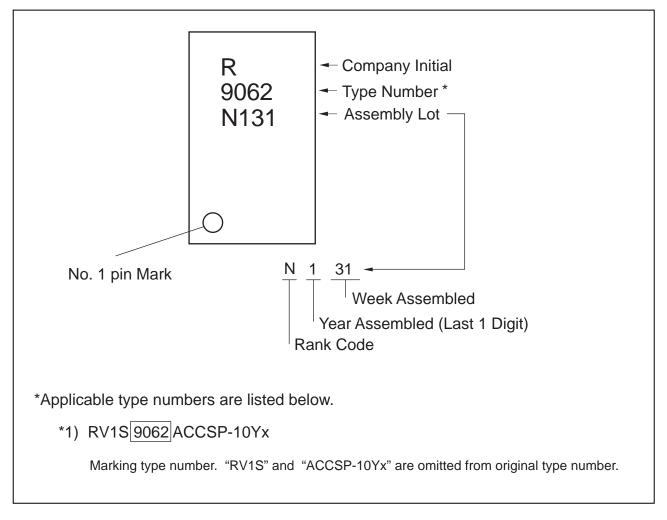
Parameter	MIN.
Air Distance	8 mm
Creepage Distance	8 mm
Isolation Distance	0.15 mm



BLOCK DIAGRAM



MARKING EXAMPLE





ORDERING INFORMATION

Part Number	Order Number	Solder Plating	Packing Style	Safety Standard	Application
		Specification		Approval	Part Number *1
RV1S9062ACCSP	RV1S9062ACCSP	Pb-Free and	20 pcs	Standard products	RV1S9062A
-10YC	-10YC#SC0	Halogen Free	(Tape 20 pcs cut)	(UL, CSA approved)	
	RV1S9062ACCSP	(Ni/Pd/Au)	Embossed Tape		
	-10YC#KC0		3 000 pcs/reel		
RV1S9062ACCSP	RV1S9062ACCSP		20 pcs	UL, CSA,	
-10YV	-10YV#SC0		(Tape 20 pcs cut)	DIN EN 60747-5-5	
	RV1S9062ACCSP		Embossed Tape	approved	
	-10YV#KC0		3 000 pcs/reel		

Notes:*1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current *1	lF	25	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	-0.5 to +30	V
	Output Voltage	Vo	-0.5 to Vcc	V
	Output Current	lo	25	mA
	Power Dissipation *2	Pc	250	mW
Isolation Vo	Itage *3	BV	5 000	Vr.m.s.
Operating A	mbient Temperature	TA	-40 to +125	°C
Storage Ter	nperature	T _{stg}	–55 to +150	°C

Notes: *1. Reduced to 0.325 mA/°C at T_{A} = 85 °C or more.

*2. Reduced to 4.15 mW/°C at T_{A} = 85 °C or more.

*3. AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-5 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	4.5		30	V
Forward Current (ON)	IF (ON)	6		12	mA
Forward Voltage (OFF)	VF (OFF)	0		0.8	V
Supply Voltage Ramp Slew Rate	SR			0.5	V/µs
Operating Ambient Temperature	TA	-40		125	°C



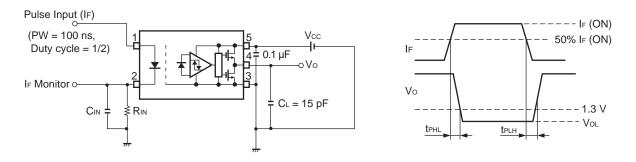
ELECTRICAL CHARACTERISTICS ($T_A = -40$ to +125 °C, $V_{CC} = 4.5$ to 30 V)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	IF = 6 mA, T _A = 25 °C	1.4	1.54	1.7	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25 °C			10	μΑ
	Input Capacitance	Ct	$V_F = 0 V, f = 1 MHz$		30		pF
Detector	Low Level Output Voltage	V _{OL}	$I_F = 6 \text{ mA}, I_O = 3.5 \text{ mA}$			0.3	V
			IF = 6 mA, Io = 6.5 mA			0.5	
	High Level Output Voltage	Vон	I _F = 0 mA, I _O = -3.5 mA	Vcc-1.5			V
			I _F = 0 mA, I _O = -6.5 mA	Vcc-2.0			
	Low Level Supply Current	ICCL	I _F = 6 mA, V _{CC} = 30 V		1.7	3	mA
	High Level Supply Current	Іссн	$I_F = 0 \text{ mA}, V_{CC} = 30 \text{ V}$		1.7	3	mA
	UVLO Threshold	Vuvlo	$V_0 < 1 V, I_F = 0 mA$		3		V
Coupled	Threshold Input Current	IFHL	$V_{CC} = 15 \text{ V}, \text{ V}_{O} < 0.3 \text{ V},$			4.1	mA
	$(H \rightarrow L)$		lo = 3.5 mA				
	Isolation Resistance	Rı-o	$V_{I-O} = 1 \text{ kV dc}, \text{ RH} \leq 60 \%,$	10 ¹¹			Ω
			T _A = 25 °C				
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.6		pF
	Propagation Delay Time	t _{PHL}	$V_{IN} = 0 \rightarrow 5 \text{ V}, \text{C}_{IN} = 60 \text{ pF},$			60	ns
	$(H \rightarrow L)^{*2}$		$R_{IN} = 560 \ \Omega, \ C_L = 15 \ pF,$				
			V _{THHL} = 1.3 V				
	Propagation Delay Time	t PLH	$V_{IN} = 5 \rightarrow 0 \text{ V}, C_{IN} = 60 \text{ pF},$			60	ns
	$(L \rightarrow H)^{*2}$		$R_{IN} = 560 \ \Omega, \ C_L = 15 \ pF,$				
			VTHLH = 1.3 V				
	Pulse Width Distortion	tphl-tplh	$V_{IN} = 0 \Leftrightarrow 5 V, C_{IN} = 60 pF,$			20	ns
	(PWD)		$R_{IN} = 560 \ \Omega, \ C_L = 15 \ pF,$				
	Propagation Delay		VTHHL=VTHLH= 1.3 V			25	
	Difference Between Any						
	Two Parts (PDD)			400			1.577
	Common Mode Transient	CM _H	$V_{CC} = 30 \text{ V}, \text{T}_{A} = 25 ^{\circ}\text{C},$	100			kV/μs
	Immunity at High Level Output *3		Vo > 17 V, IF = 0 mA, V _{CM} = 1.5 kV				
	Common Mode Transient	CM∟	$V_{CC} = 30 \text{ V}, \text{ T}_{A} = 25 \text{ °C},$	100			kV/μs
	Immunity at Low Level		$V_{CC} = 30 V$, $T_A = 25 C$, $V_0 < 1 V$,	100			κv/μS
	Output *3		$ V_0 < 1V$, $ F = 6 \text{ mA}$, $ V_{CM} = 1.5 \text{ kV}$				
			r - 0 /2, v = 1.0 KV				

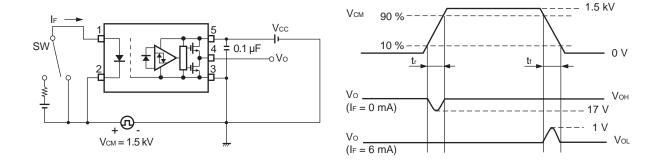
Notes: *1. Typical values at $T_A = 25$ °C.



*2. Test circuit for propagation delay time



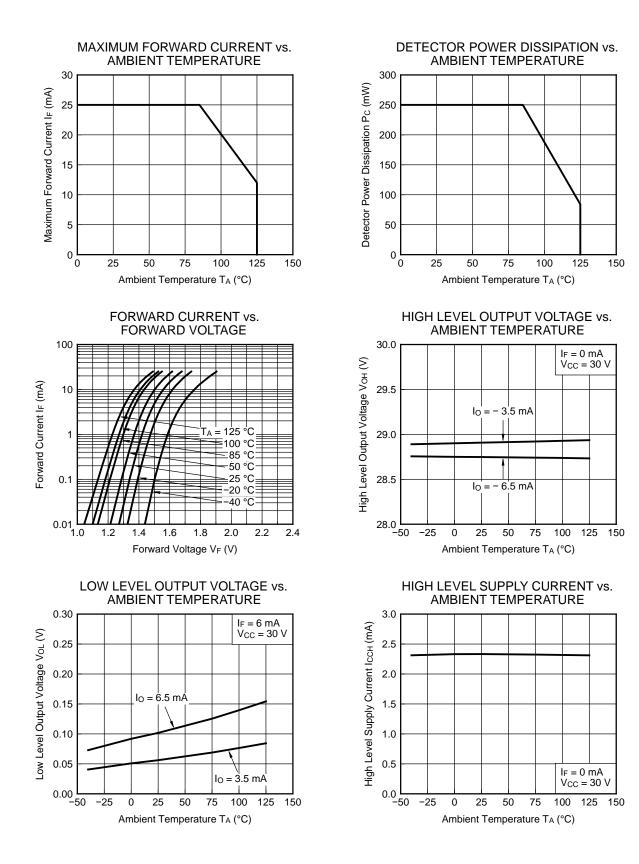
Remark C_L includes probe and stray wiring capacitance.



*3. Test circuit for common mode transient immunity



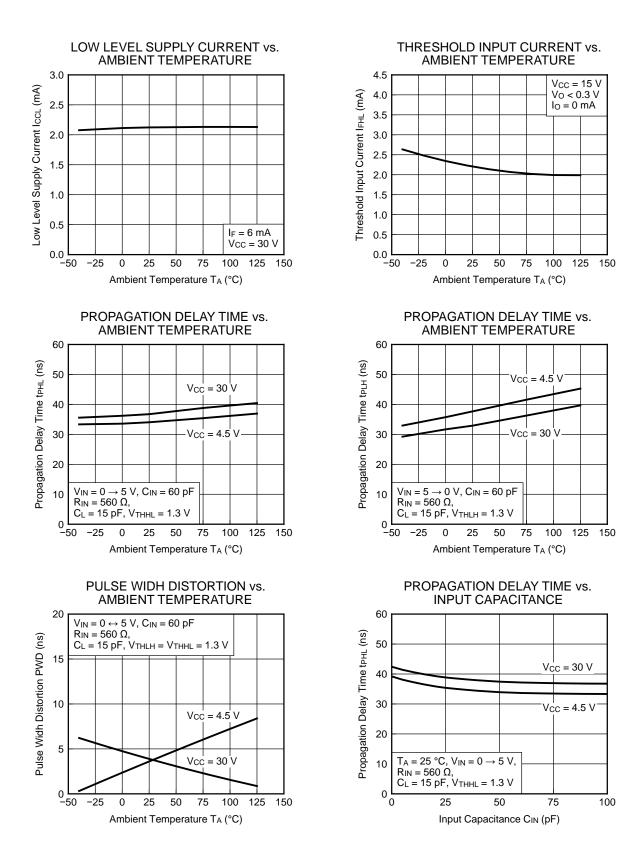
TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.



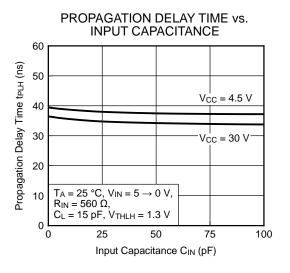
TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



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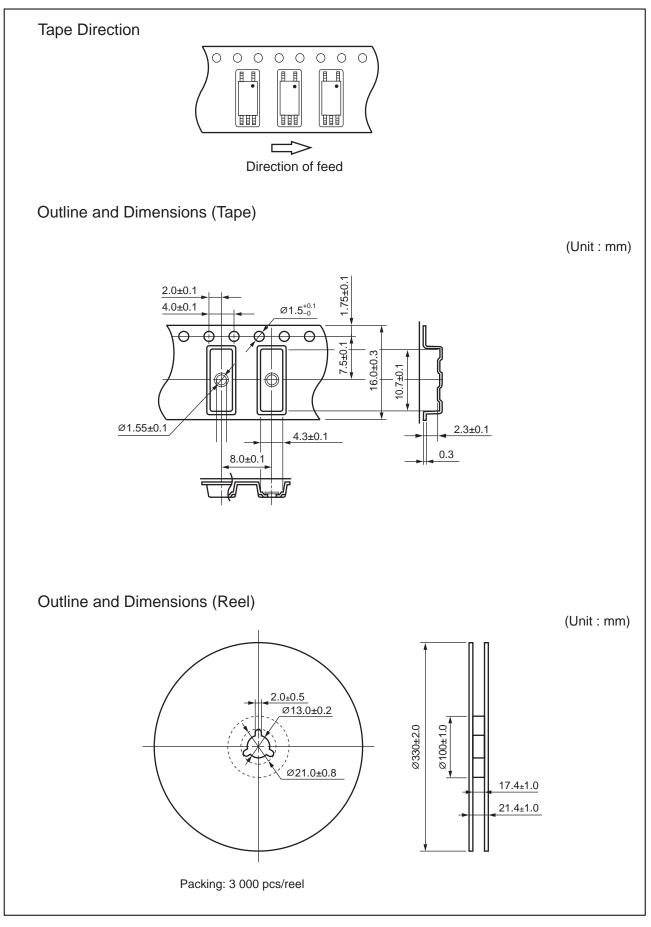
TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

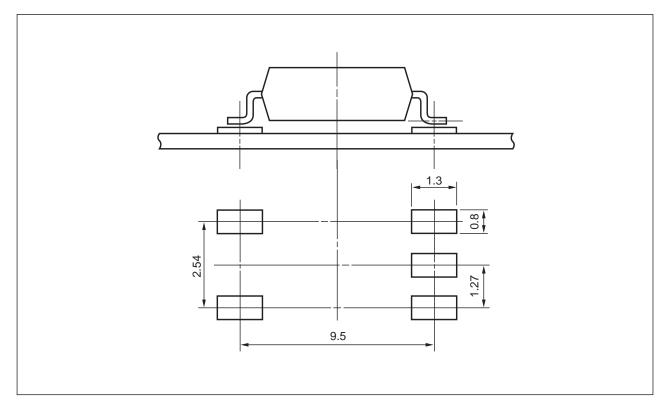


TAPING SPECIFICATIONS (UNIT : mm)





RECOMMENDED MOUNT PAD DIMENSIONS (UNIT : mm)



Remark All dimensions in this figure must be evaluated before use.



NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature -5 °C (255 °C)
 - Time of temperature higher than 217 °C ٠
 - Time to preheat temperature from 150 to 200 °C
 - Number of reflows •
 - Flux

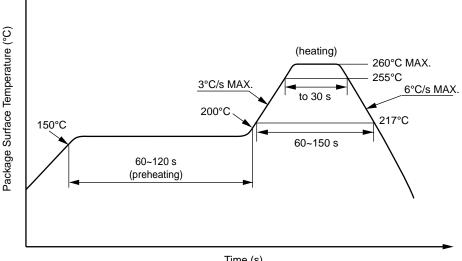
260 °C or below (package surface temperature) 30 seconds or less 60~150 seconds

60~120 seconds

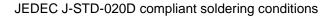
Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow







(2) Wave soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120 °C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Rosin flux containing small amount of chlorine (The flux with a maximum Flux chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350 °C or below
- Time (each pins) 3 seconds or less
 - Flux Rosin flux containing small amount of chlorine
 - (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

- Flux Cleaning
 - Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- Do not use fixing agents or coatings containing halogen-based substances.



2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

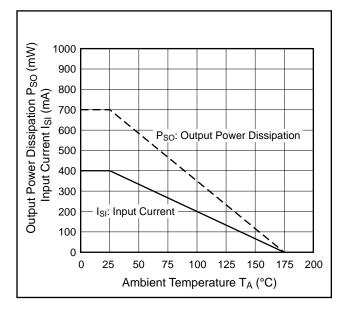
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.



SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

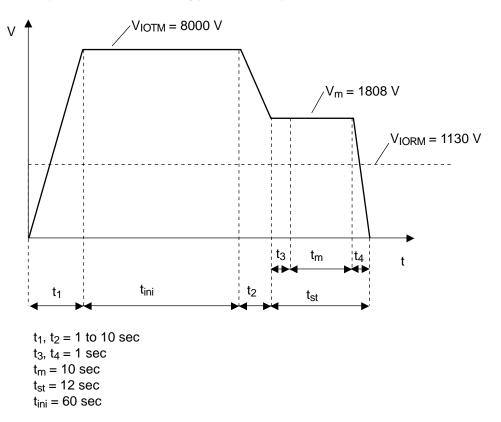
Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/125/21	
Dielectric strength maximum operating isolation voltage	VIORM	1 130	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	Vm	1 808	V_{peak}
$V_m = 1.6 \times V_{IORM.}, q_{pd} < 5 \ pC$			
Test voltage (partial discharge test, procedure b for all devices) V_m = 1.875 \times $V_{IORM.},q_{pd}$ < 5 pC	Vm	2 119	V_{peak}
Highest permissible overvoltage	VIOTM	8 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	СТІ	400	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		Π	
Storage temperature range	T _{stg}	$-55 \sim +150$	°C
Operating temperature range	TA	-40~+125	°C
Isolation resistance, minimum value			
V _{I-O} = 500 V dc, T _A = 25 °C	R⊦o MIN.	10 ¹²	Ω
V_{I-O} = 500 V dc, T_A = maximum temperature of rating, at least 100 °C	R⊦₀ MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)			
Maximum ambient temperature	Ts	175	°C
Maximum input current	Isi	400	mA
Maximum output power dissipation	Pso	700	mW
Isolation resistance, minimum value at V_{I-O} = 500 V dc, $T_A = T_S$	R⊦o MIN.	10 ⁹	Ω

Dependence of maximum safety ratings on ambient temperature

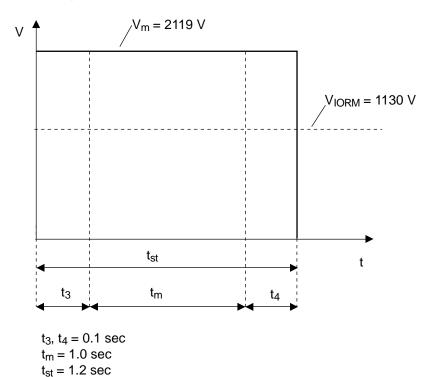




Method a) Destructive Test, Type and Sample Test



Method b) Non-destructive Test, 100% Production Test



R08DS0270EJ0100 Rev.1.00

May 09, 2022

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

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